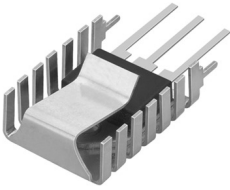


# Data sheet Product FK 245 MI 247 V



Board Level heatsinks > Attachable heatsink  
vertical mounting, for semiconductor-design TO 218, TO 220, TO 247

## Features

material:	copper (Cu)
for transistor:	<ul style="list-style-type: none"> <li>• TO 220</li> <li>• TO 248</li> <li>• SIP-Multiwatt</li> <li>• TO 247</li> <li>• TO 218</li> </ul>
width:	20 mm
height:	9 mm
length:	32 mm
thermal resistance:	19.7 K/W
surface:	solderable surface
version:	with solder lug for vertical installation
material thickness:	0.6 mm

## Technical Drawing

